

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





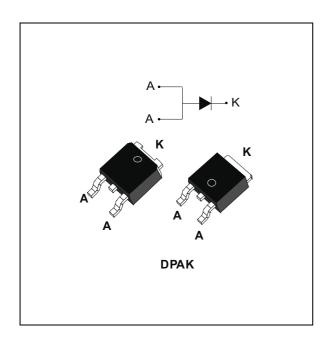


STPS1045B



Power Schottky rectifier

Datasheet - production data



Description

High voltage Schottky rectifier suited for switch mode power supply and other power converters.

Packaged in DPAK, this device is intended for use in high frequency circuitries where low switching losses is required.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	10 A
V_{RRM}	45 V
T _j	175 °C
V _{F(typ)}	0.50 V

Features

- Very small conduction losses
- · Extremely fast switching
- Low thermal resistance
- Negligible switching losses
- Low forward voltage drop
- Low capacitance
- Avalanche specification
- ECOPACK[®]2 compliant component for DPAK on demand

Characteristics STPS1045B

1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C unless otherwise stated)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	45	V	
I _{F(RMS)} / pin	Forward rms current	7	Α	
I _{F(AV)}	Average forward current, $\delta = 0.5$, square wave	T _C = 150 °C	10	Α
I _{FSM}	Surge non repetitive forward current	$t_p = 10 \text{ ms sinusoidal}$	75	Α
P _{ARM}	Repetitive peak avalanche power	285	W	
T _{stg}	Storage temperature range	-65 to +175	°C	
T _j	Maximum operating junction temperature ⁽¹⁾	175	°C	

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Max. value	Unit	
R _{th(j-c)}	Junction to case	3	°C/W	

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	L (1) Deveree leeke se surrent	T _j = 25 °C	V V	-		100	μΑ
I _R (1) Reverse leakage current	T _j = 125 °C	$V_R = V_{RRM}$	-	7	15	mA	
	V (2) Farmer durations duran	T _j = 25 °C	I _F = 10 A	1		0.63	
V _F ⁽²⁾		T _j = 125 °C		-	0.50	0.57	V
V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 20 A	-		0.84	V	
	T _j = 125 °C		-	0.65	0.72		

^{1.} Pulse test: $t_p = 5$ ms, $\delta < 2\%$

To evaluate the conduction losses, use the following equation:

$$P = 0.42 \times I_{F(AV)} + 0.015 \times I_{F}^{2}_{(RMS)}$$

^{2.} Pulse test: t_p = 380 μ s, δ < 2%

STPS1045B Characteristics

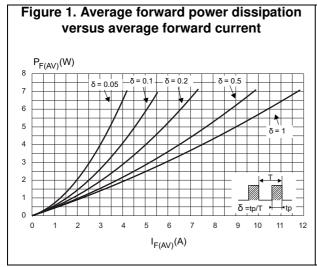
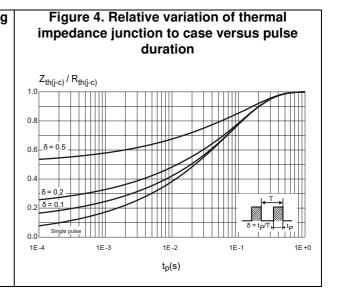
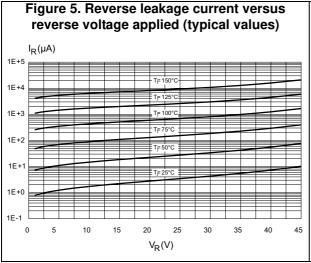


Figure 2. Average forward current versus ambient temperature ($\delta = 0.5$) $I_{F(AV)}(A)$ 12 $R_{th(j-a)} = R_{th(j-c)}$ 10 $R_{th(j-a)} = 70 \text{ °C/W}$ 0 0 25 50 75 100 125 150 175 T_{amb}(°C)

Figure 3. Normalized avalanche power derating versus pulse duration at T_j = 125 °C





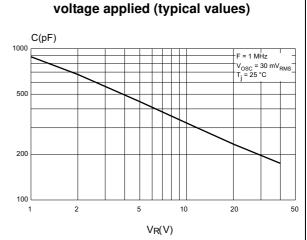
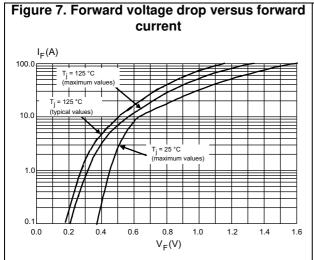
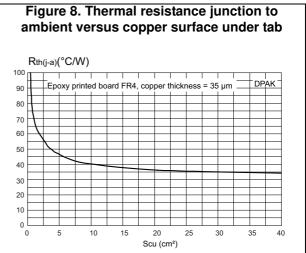


Figure 6. Junction capacitance versus reverse

Characteristics STPS1045B





Package Information 2

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

2.1 **DPAK** package information

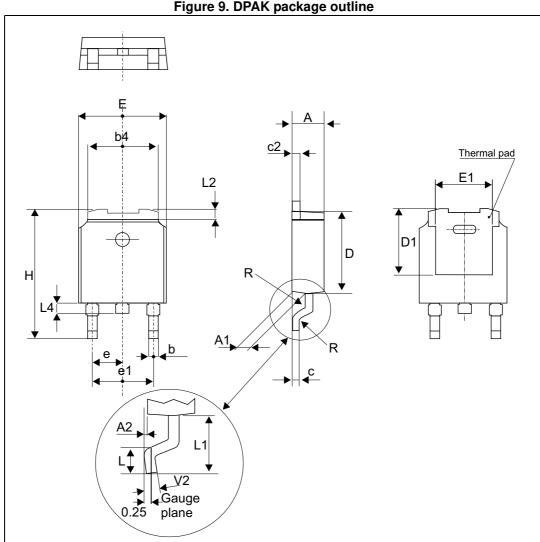


Figure 9. DPAK package outline

Note:

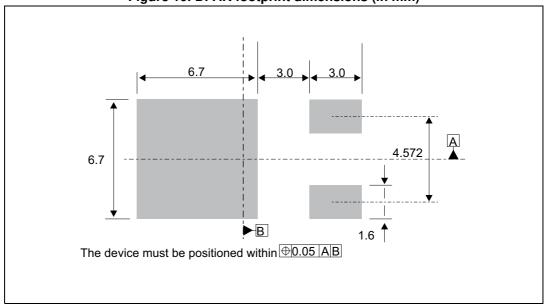
This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Package Information STPS1045B

Table 5. DPAK package mechanical data

			<u> </u>	Dimensions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.18		2.40	0.085		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.194		0.214
С	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.023
D	5.97		6.22	0.235		0.244
D1	4.95		5.60	0.194		0.220
E	6.35		6.73	0.250		0.264
E1	4.32		5.50	0.170		0.216
е		2.28			0.090	
e1	4.40		4.70	0.173		0.185
Н	9.35		10.40	0.368		0.409
L	1.00		1.78	0.039		0.070
L2			1.27			0.050
L4	0.60		1.02	0.023		0.040
V2	-8°		+8°	-8°		8°

Figure 10. DPAK footprint dimensions (in mm)



3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS1045B	S10 45	DPAK	0.30 g	75	Tube
STPS1045B-TR	S10 45	DEAN	0.30 g	2500	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes	
Jul-2003	3B	Last issue	
21-Apr-2005	4	IPAK package removed	
03-Nov-2005	5	DPAK foot print dimensions updated.	
01-Jul-2010	6	Updated Figure 10 Updated ECOPACK statement.	
04-Nov-2014	7	Updated DPAK package information, Table 2 and Figure 5. Removed P_{ARM} ($T_j = 25$ °C).	
07-Apr-2015	8	Updated Table 2. Format update to current standard.	
05-Oct-2016	9	Updated DPAK package information.	

IMPORTANT NOTICE - PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2016 STMicroelectronics - All rights reserved